ABSTRACT

A glass for laser processing of the present invention can be laser-processed by causing ablation or evaporation by laser beam energy absorbed therein, wherein the glass for laser processing has a composition that satisfies the following conditions:

$$60 \le SiO_2 + B_2O_3 \le 79 \text{ mol}\%;$$

$$5 \le Al_2O_3 + TiO_2 \le 20 \text{ mol}\%$$
; and

$$5 \leq \mathrm{Li}_2\mathrm{O} + \mathrm{Na}_2\mathrm{O} + \mathrm{K}_2\mathrm{O} + \mathrm{Rb}_2\mathrm{O} + \mathrm{Cs}_2\mathrm{O} + \mathrm{MgO} + \mathrm{CaO} + \mathrm{SrO} + \mathrm{BaO} \leq$$

10 20 mol%,

5

where $5 \le \text{TiO}_2 \le 20 \text{ mol}\%$. The present invention can provide a glass for laser processing that has a low laser processing threshold value as well as a low thermal expansion coefficient.